

HSF

NOTES:

Current Rating: 2.0AMP
 Current Resistance: 20mΩ Max
 Withstand Voltage: 500V AC/DC
 Insulation Resistance: 1000MΩ Min
 Operation Temperature: -40°C to +105°C

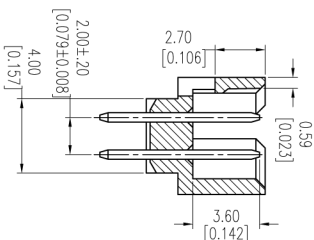
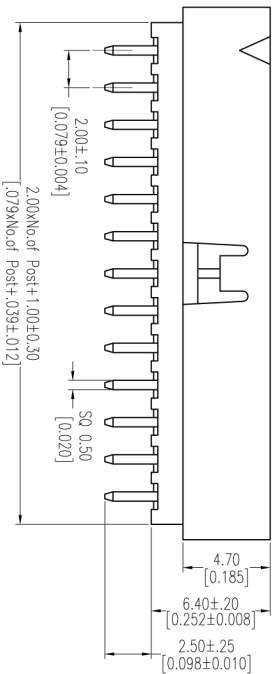
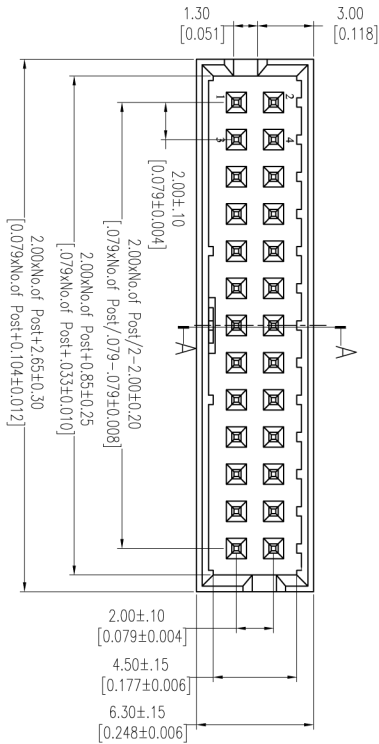
Contact Material: Brass
 Contact plating: Au Or Sn over Ni
 Insulator Material: PA9T+50%GF UL94V-0

Ordering Information

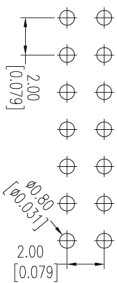
3121B-XX S XX B K00 X 1

△ No. of Pins	8 26	Contact Plating	Color Insulator	Packing
10 30	OP=Gold Flash	B=Black	T=Tube	
16 40	GS=3u"Gold			
20 44	GS=5u"Gold			
24 48	SP=Gold Flash/Tin			
	SS=3u"Gold/Tin			
	SS=5u"Gold/Tin			
	SS=30u"Gold/Tin			
	SN=Tin			

Item	Pitch	Mating
Standard	2.00	5223
Alternate		



Recommended P.C.B Layout (Top Side)
 (PCB BOARD TOLERANCE±0.05)



OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
XX ±0.40	Allen	2015/08/27	mm		3121B-XXSXBK00X1
XXX ±0.25	CHECK	DATE	UNIT		TITLE:
X.XXX ±0.15			mm		2.00 BOX HEADER 180°DIP
Angle ± 3°	APPROVE	DATE	SIZE		H=6.4 With Middle Cut
DIM TOL			SHEET		Customer NO.
			1/1		
			PROJ.		

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A1	2015/08/27	Modify
A0	2012/09/24	NEW
REV	DATE	MODIFICATION DESCRIPTION
		CHANGE